

# RELIABILITY MONITOR

PRODUCT	MONITOR DATE	DATE CODE	ASSEMBLY FACILITY	ASSEMBLY LOT NO	PROCESS TYPE	PACKAGE TYPE
DS2250 32K - 16 Mhz	Dec-95	9547	DALLAS	70692	PCB	SIPSTIK

## STRESS/JOB NO.

## READPOINT (Sample Size/No. of Fails)

Hi Temp Storage 85°C, No Bias P-16745	<u>336 Hr</u> 11/0	<u>1000 Hr</u> 11/0	<u>Cum %</u> 0.0%
Temp Cycle -40°C to +85°C P-16746	<u>100 ~</u> 11/0	<u>500 ~</u> 11/0	<u>Cum %</u> 0.0%
Moisture Soak 60°C / 90% R.H. P-16747	<u>192 Hr</u> 11/0	<u>384 Hr</u> 11/1 F1	<u>Cum %</u> 9.1%

## Failure Mode

F1: Branch